

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4189666

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JIYOU FU	09/25/2016
STILIAN IVANOV PANDEV	09/20/2016
KEVIN A. PETERLINZ	11/03/2016
NOAM SAPIENS	09/27/2016
RECEIVING PARTY DATA	
Name:	KLA-TENCOR CORPORATION
Street Address:	ONE TECHNOLOGY DRIVE
City:	MILPITAS
State/Country:	CALIFORNIA
Postal Code:	95035
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15271179
CORRESPONDENCE DATA	
Fax Number:	(650)307-0332
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	isabelle@spanolawgroup.com
Correspondent Name:	JOSEPH S SPANO
Address Line 1:	851 BURLWAY ROAD, SUITE 407
Address Line 4:	BURLINGAME, CALIFORNIA 94010
ATTORNEY DOCKET NUMBER:	KLA-082 (P4769)
NAME OF SUBMITTER:	JOSEPH S. SPANO
SIGNATURE:	/Joseph S. Spano/
DATE SIGNED:	12/18/2016
Total Attachments: 4	
source=KLA-082-P4769-Assignment-Fu-signed#page1.tif	
source=KLA-082-P4769-Assignment-pandev-signed#page1.tif	
source=KLA-082-P4769-Assignment-Peterlinz-signed#page1.tif	

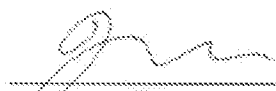
ASSIGNMENT OF PATENT APPLICATION

WHEREAS, we, Jiyou Fu, 1303 Glenmoor Way, San Jose, California 95129; Noam Sapiens, 10403 Denison Avenue, Cupertino, California 95014; Kevin A. Peterlinz, 7566 May Way, San Ramon, CA 94583; Stilian Ivanov Pandev, 2452 Rebecca Lynn Way, Santa Clara, California 95050; (hereinafter referred to as ASSIGNORS), having post office addresses that follow our names, are the joint inventors of the invention described and claimed in the specification forming part of the United States patent application entitled "Spectroscopic Beam Profile Overlay Metrology," which was filed on September 20, 2016, and now has U.S. Application Ser. No. 15/271,179;

WHEREAS, KLA-Tencor Corporation, (hereafter referred to as ASSIGNEE), a corporation organized under the laws of Delaware and having a place of business at One Technology Drive, Milpitas, California 95035, is desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted therefor in the United States and in any and all foreign countries;

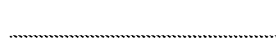
NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE, its successors and assigns, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE, its successors and assigns, and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE, its successors and assigns. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.


Inventor's Signature

Jiyou Fu
Inventor's Printed Name

9/25/16
Date


Inventor's Signature

Noam Sapiens
Inventor's Printed Name

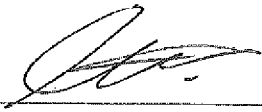
Date

Assignment of application entitled: "Spectroscopic Beam Profile Overlay Metrology"
Docket Number: KLA-082 (P4769)

Inventor's Signature

Kevin A. Peterlinz
Inventor's Printed Name

Date

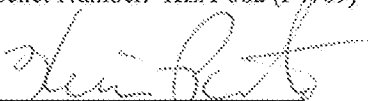


Inventor's Signature

Stilian Ivanov Pandev
Inventor's Printed Name

9/20/2016
Date

Assignment of application entitled: "Spectroscopic Beam Profile Overlay Metrology"
Docket Number: KLA-082 (P4769)


Inventor's Signature

Kevin A. Peterlinz
Inventor's Printed Name

11/03/2016
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Stilian Ivanov Pandev
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ASSIGNMENT OF PATENT APPLICATION

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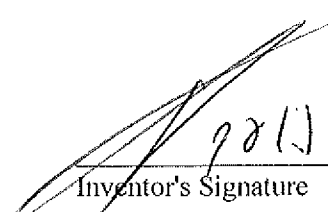
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Noam Sapiens
Inventor's Printed Name

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